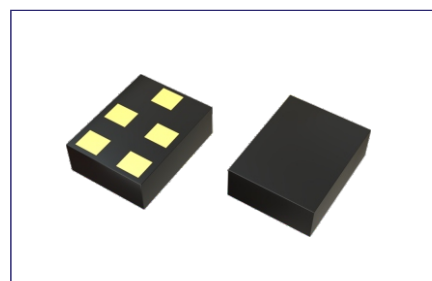


SMD 1.4X1.1X0.6 CSP PACKAGE

PRODUCT FEATURES

- Ultra Small size 1.4x1.1x0.6mm
- CSP process with chip scale package
- Standardization of small size
- Good stability and high reliability
- Mainly used in GPS navigation
- TDD/FDD communication and artificial intelligence chips
- ROHS compliant

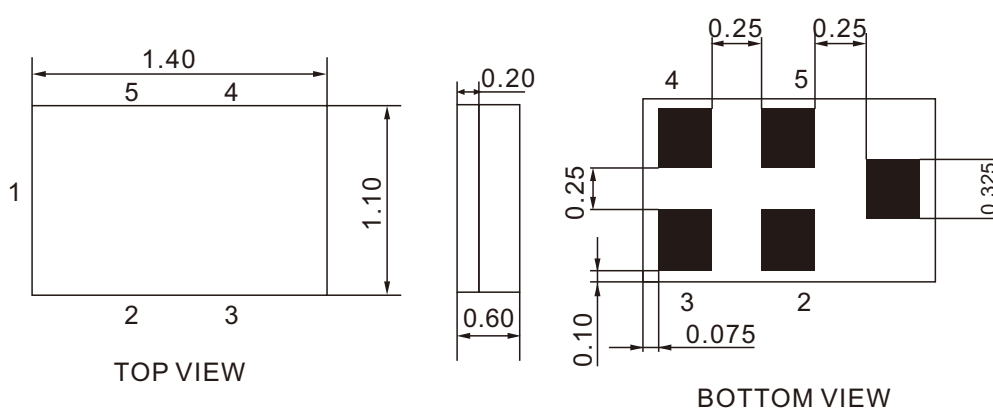
PRODUCT PHOTO



PRODUCT SPECIFICATIONS

Item		Specifications	Unit
Frequency Range	f_c	800~3600MHz	MHz
Standard Frequency		1575.42, 1582.4, 1568, 2655	MHz
Useful Band Width		3, 18, 48 or specify	MHz
Insertion Loss (min)	IL	0.9, 1.3, 1.8, 2.2 or specify	dB
VSWR(max)		2.0	dB
Operating Temperature Range		-40~+85	°C
Storage Temperature Range		-40~+85	°C

PACKAGE OUTLINE / DIMENSIONS



Pin No.	Description
1	Input
4	Output
2,3,5	To be grounded

单击下面可查看定价，库存，交付和生命周期等信息

[>>Hang Crystal International\(苏州杭晶电子科技有限公司\)](#)